#### PACKAGE/ORDERING INFORMATION

MODEL	RESET THRESHOLD (V)	PACKAGE DESCRIPTION	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
	4.63	SOIC-8	SGM706B-LXS8G/TR	SGM 706BLXS8 XXXXX	Tape and Reel, 4000
	4.63	MSOP-8	SGM706B-LXMS8G/TR	SGM706BL XMS8 XXXXX	Tape and Reel, 4000
	4.38	SOIC-8	SGM706B-MXS8G/TR	SGM 706BMXS8 XXXXX	Tape and Reel, 4000
	4.38	MSOP-8	SGM706B-MXMS8G/TR	SGM706BM XMS8 XXXXX	Tape and Reel, 4000
	4.0 SOIC-8 SGM706B-JXS8G/TR SGM 706BJXS8 XXXXX		706BJXS8	Tape and Reel, 4000	
SGM706B	4.0	MSOP-8	SGM706B-JXMS8G/TR	SGM706BJ XMS8 XXXXX	Tape and Reel, 4000
SGIMTOOB	3.08	SOIC-8	SGM706B-TXS8G/TR	SGM 706BTXS8 XXXXX	Tape and Reel, 4000
	3.08	MSOP-8	SGM706B-TXMS8G/TR	SGM706BT XMS8 XXXXX	Tape and Reel, 4000
	2.93	SOIC-8	SGM706B-SXS8G/TR	SGM 706BSXS8 XXXXX	Tape and Reel, 4000
	2.93	MSOP-8	SGM706B-SXMS8G/TR	SGM706BS XMS8 XXXXX	Tape and Reel, 4000
	2.63	SOIC-8	SGM706B-RXS8G/TR	SGM 706BRXS8 XXXXX	Tape and Reel, 4000
	2.63	MSOP-8	SGM706B-RXMS8G/TR	SGM706BR XMS8 XXXXX	Tape and Reel, 4000

#### **MARKING INFORMATION**

NOTE: XXXXX = Date Code, Trace Code and Vendor Code.



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

#### **ABSOLUTE MAXIMUM RATINGS**

Terminal Voltage (With Respect to GND)
V <sub>CC</sub> 0.3V to 6.0V
All Other Inputs0.3V to (V <sub>CC</sub> + 0.3V)
Input Current
V <sub>CC</sub>
GND 20mA
Output Current
All Outputs20mA
Package Thermal Resistance
SOIC-8, θ <sub>JA</sub> 145°C/W
MSOP-8, θ <sub>JA</sub> 190°C/W
Junction Temperature+150°C
Storage Temperature Range65°C to +150°C
Lead Temperature (Soldering, 10s)+260°C
ESD Susceptibility
HBM4000V
MM400V
CDM1000V

#### RECOMMENDED OPERATING CONDITIONS

Ambient Temperature Range .....-40°C to +125°C

#### **OVERSTRESS CAUTION**

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

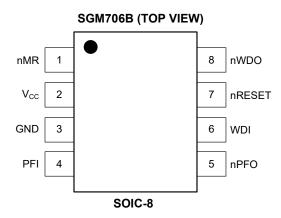
#### **ESD SENSITIVITY CAUTION**

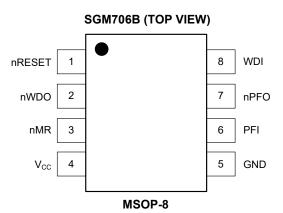
This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### **DISCLAIMER**

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

#### **PIN CONFIGURATIONS**





#### **PIN DESCRIPTION**

PIN		NAME	FUNCTION				
SOIC-8	MSOP-8	NAME	FUNCTION				
1	3	nMR	Manual Reset Input Pin. Manual reset input triggers a reset pulse when pulled below 0.8V. This active-low input has an internal 234 $\mu$ A (V <sub>CC</sub> = +5V) pull-up current. It can be driven from a TTL or CMOS logic line as well as shorted to ground with a switch.				
2	4	V <sub>CC</sub>	Power Supply Voltage. Power supply voltage that is monitored.				
3	5	GND	Ground. 0V ground reference for all signals.				
4	6	PFI	Power-Fail Voltage Monitor Input Pin. When PFI is less than 1.25V, nPFO goes low. Connect PFI to GND or $V_{\rm CC}$ when not used.				
5	7	nPFO	Power-Fail Output Pin. Power-fail output goes low and sinks current when PFI is less than 1.25V; otherwise nPFO stays high.				
6	8	WDI	Watchdog Input Pin. If WDI remains high or low for 1.6s, the internal watchdog timer runs out and nWDO goes low. Floating WDI or connecting WDI to a high-impedance three-state buffer disables the watchdog feature. The internal watchdog timer clears whenever reset is asserted, WDI is three-stated, or WDI sees a rising or falling edge.				
7	1	nRESET	Reset Pin. Active-low reset output pulses low for 200ms when triggered, and stays low whenever $V_{\text{CC}}$ is below the reset threshold (4.63V for SGM706B-L, 4.38V for SGM706B-M, 4.0V for SGM706B-J, 3.08V for SGM706B-T and 2.93V for SGM706B-S, 2.63V for SGM706B-R). It remains low for 200ms after $V_{\text{CC}}$ rises above the reset threshold or nMR goes from low to high. A watchdog timeout will not trigger nRESET unless nWDO is connected to nMR.				
8	2	nWDO	Watchdog Output Pin. Watchdog output pulls low when the internal watchdog timer finishes its 1.6sec count and does not go high again until the watchdog is cleared. nWDO also goes low during low-line conditions. Whenever $V_{\rm CC}$ is below the reset threshold, nWDO stays low; however, unlike nRESET, nWDO does not have a minimum pulse width. As soon as $V_{\rm CC}$ rises above the reset threshold, nWDO goes high with no delay.				

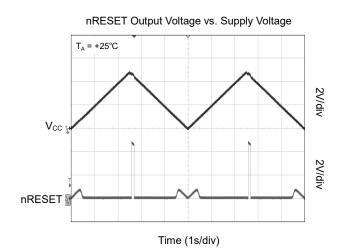
#### **ELECTRICAL CHARACTERISTICS**

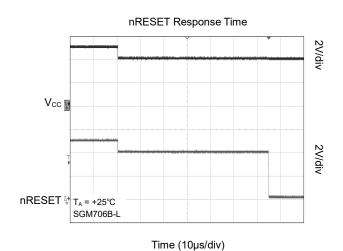
 $(T_A = +25^{\circ}C, V_{CC} = 4.72V \text{ to } 5.5V \text{ for SGM706B-L}; V_{CC} = 4.47V \text{ to } 5.5V \text{ for SGM706B-M}; V_{CC} = 4.08V \text{ to } 5.5V \text{ for SGM706B-J}; V_{CC} = 3.15V \text{ to } 5.5V \text{ for SGM706B-T}; V_{CC} = 2.99V \text{ to } 5.5V \text{ for SGM706B-S}; V_{CC} = 2.69V \text{ to } 5.5V \text{ for SGM706B-R}, Full = -40^{\circ}C \text{ to } +125^{\circ}C, \text{ unless otherwise noted.})$ 

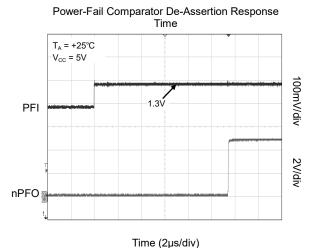
PARAMETER		CONDITIONS	TEMP	MIN	TYP	MAX	UNITS	
Operating Voltage Range (V <sub>CC</sub> )			Full	1.0		5.5	V	
Owner by Owner at (I)		V <sub>CC</sub> = 3.6V	Full		0.6	1.2	μA	
Supply Current (I <sub>SUPPLY</sub> )		V <sub>CC</sub> = 5.5V	Full		0.8	1.5	μA	
		0.0147000 1	+25°C	4.55	4.63	4.70		
		SGM706B-L	Full	4.52	4.63	4.72		
			+25°C	4.30	4.38	4.45		
		SGM706B-M	Full	4.28	4.38	4.47	_	
			+25°C	3.93	4.0	4.07		
		SGM706B-J	Full	3.92	4.0	4.08		
nRESET Threshold (V <sub>nRST</sub> )			+25°C	3.03	3.08	3.14	V	
		SGM706B-T	Full	3.02	3.08	3.15	4	
							4	
		SGM706B-S	+25°C	2.88	2.93	2.98		
			Full	2.87	2.93	2.99	_	
		SGM706B-R	+25°C	2.58	2.63	2.68		
			Full	2.57	2.63	2.69	<b></b>	
		SGM706B-L	+25°C		20			
		SGM706B-M	+25°C		19			
		SGM706B-J	+25°C		17			
nRESET Threshold Hysteresis		SGM706B-T	+25°C		13		- mV -	
		SGM706B-S	+25°C		13			
		SGM706B-R	+25°C		11			
nRESET Threshold Temperature Coefficient			Full		20		ppm/°C	
nRESET Pulse Width (t <sub>RS</sub> )			Full	140	200	290	ms	
		I <sub>SOURCE</sub> = 800µA	Full	V <sub>CC</sub> - 1.5			V	
nRESET Output Voltage		I <sub>SINK</sub> = 3.2mA	Full			0.4		
		$V_{CC} = 1V$ , $I_{SINK} = 50\mu A$	Full			0.3		
Watchdog Timeout Period (t <sub>WD</sub> )			Full	1.1	1.6	2.4	S	
WDI Pulse Width (t <sub>WP</sub> )	1	$V_{IL} = 0V$ , $V_{IH} = V_{CC}$	Full	90			ns	
	Low	V <sub>CC</sub> = 5V	Full			8.0		
WDI Input Threshold	High	V <sub>CC</sub> = 5V	Full	3.5			V	
·	Low	$V_{\text{nRST(MAX)}} < V_{\text{CC}} < 3.6V$	Full	0.7. \		0.8	4	
	High	$V_{\text{nRST(MAX)}} < V_{\text{CC}} < 3.6V$	Full	0.7 × V <sub>CC</sub>	0.04	4.0		
WDI Input Current		WDI = V <sub>CC</sub> WDI = 0V	Full	4.0	0.01	1.0	μΑ	
			Full Full	-1.0	-0.01			
nWDO Output Voltage		$I_{SOURCE} = 800\mu A$ $I_{SINK} = 1.2mA$	Full	V <sub>CC</sub> - 1.5		0.2	V	
nMR Pull-Up Current		$nMR = 0V, V_{CC} = 5V$	Full	100		300	μA	
	•		Full	300		300	ns	
·	` '			500		0.0	113	
nMR Pulse Width (t <sub>MR</sub> )	Low		Full				V	
·	Low High		Full Full	2		0.8	V	
nMR Pulse Width (t <sub>MR</sub> )				2		420	V ns	
nMR Pulse Width (t <sub>MR</sub> ) nMR Input Threshold		V <sub>cc</sub> = 5V	Full	2 1.21	1.25			
nMR Pulse Width $(t_{MR})$ nMR Input Threshold nMR to nRESET Out Delay $(t_{MD})$		V <sub>CC</sub> = 5V	Full Full		1.25 0.2	420	ns	
nMR Pulse Width (t <sub>MR</sub> )  nMR Input Threshold  nMR to nRESET Out Delay (t <sub>MD</sub> )  PFI Input Threshold		V <sub>CC</sub> = 5V I <sub>SOURCE</sub> = 800μA	Full Full Full			420 1.29	ns V	

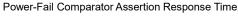


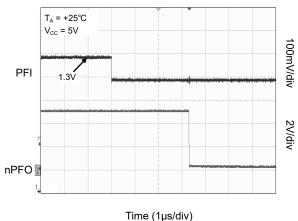
#### TYPICAL PERFORMANCE CHARACTERISTICS

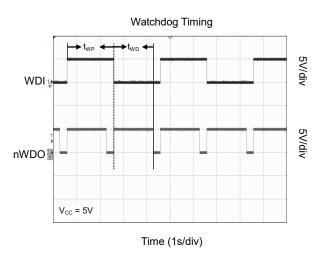


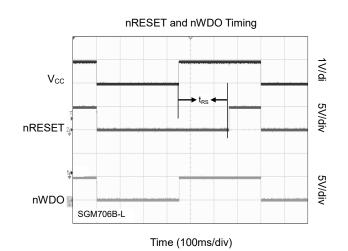




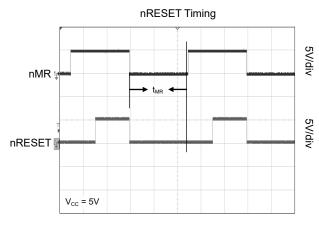






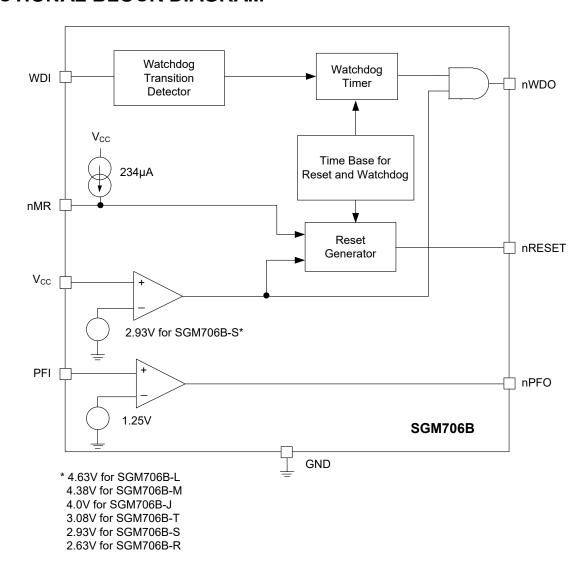


### **TYPICAL PERFORMANCE CHARACTERISTICS (continued)**



Time (200ms/div)

#### **FUNCTIONAL BLOCK DIAGRAM**



#### APPLICATION NOTES

## Ensuring a Valid nRESET Output Down to $V_{CC} = 0V$

When  $V_{CC}$  falls below 1V, the SGM706B nRESET output no longer sinks current, it becomes an open circuit. High-impedance CMOS logic inputs can drift to undetermined voltages if left undriven. If a pull-down resistor is added to the nRESET pin as shown in Figure 1, any stray charge or leakage currents will be drained to ground, holding nRESET low. Resistor value (R1) is not critical. It should be about  $100k\Omega$ , large enough not to load nRESET and small enough to pull nRESET to ground.

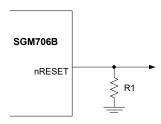


Figure 1. nRESET Valid to Ground Circuit

#### Monitoring Voltages Other Than the Unregulated DC Input

Monitor voltages other than the unregulated DC by connecting a voltage divider to PFI and adjusting the ratio appropriately. If required, add hysteresis by connecting a resistor (with a value approximately 10 times the sum of the two resistors in the potential divider network) between PFI and nPFO. A capacitor between PFI and GND will reduce the power-fail circuit's sensitivity to high-frequency noise on the line being monitored. nRESET can be asserted on other voltages in addition to the +5V V $_{\rm CC}$  line. Connect nPFO to nMR to initiate a nRESET pulse when PFI drops below 1.25V. Figure 2 shows the SGM706B configured to assert nRESET when the +5V supply falls below the reset threshold, or when the +12V supply falls below approximately 11V.

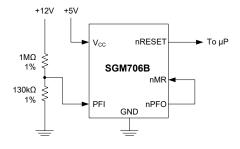


Figure 2. Monitoring Both +5V and +12V

#### **Monitoring a Negative Voltage**

The power-fail comparator can also monitor a negative supply rail (Figure 3). When the negative rail is good (a negative voltage of large magnitude), nPFO is low, and when the negative rail is degraded (a negative voltage of lesser magnitude), nPFO is high. By adding the resistors and transistor as shown, a high nPFO triggers reset. As long as nPFO remains high, the SGM706B will keep reset asserted (nRESET = low). Note that this circuit's accuracy depends on the PFI threshold tolerance, the V<sub>CC</sub> line, and the resistors.

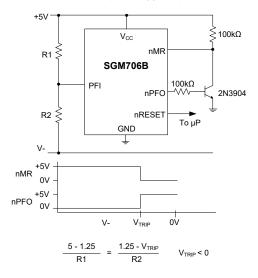


Figure 3. Monitoring a Negative Voltage

### Interfacing to µPs with Bidirectional Reset Pins

μPs with bidirectional reset pins, such as the Motorola 68HC11 series, can contend with the SGM706B nRESET output. If, for example, the nRESET output is driven high and the microprocessor wants to pull it low, indeterminate logic levels may result in. To correct this, connect a 4.7kΩ resistor between the nRESET output and the μP reset I/O, as show in Figure 4. Buffer the nRESET output to other system components.

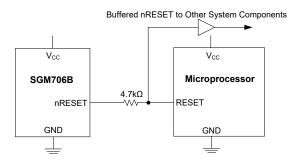


Figure 4. Interfacing to Microprocessors with Bidirectional Reset I/O



## Low-Cost, Microprocessor Supervisory Circuit

#### **SGM706B**

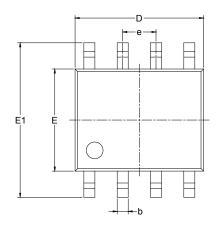
#### **REVISION HISTORY**

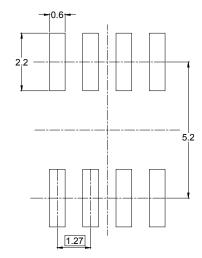
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Original (DECEMBER 2018) to REV.A

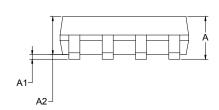


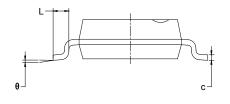
# PACKAGE OUTLINE DIMENSIONS SOIC-8





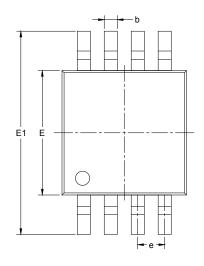
RECOMMENDED LAND PATTERN (Unit: mm)

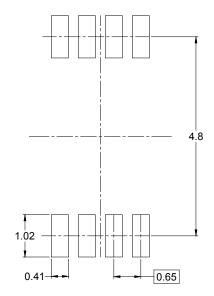




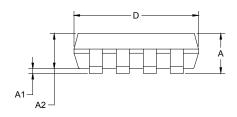
Symbol		nsions meters	Dimensions In Inches			
,	MIN	MAX	MIN	MAX		
А	1.350 1.750		0.053	0.069		
A1	0.100	0.250	0.004	0.010		
A2	1.350	1.550	0.053	0.061		
b	0.330	0.510	0.013	0.020		
С	0.170	0.250	0.006	0.010		
D	4.700	5.100	0.185	0.200		
E	3.800	4.000	0.150	0.157		
E1	5.800	6.200	0.228	0.244		
е	1.27	BSC	0.050	BSC		
L	0.400	1.270	0.016	0.050		
θ	0°	8°	0°	8°		

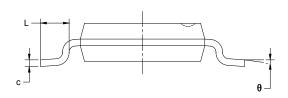
# PACKAGE OUTLINE DIMENSIONS MSOP-8





RECOMMENDED LAND PATTERN (Unit: mm)

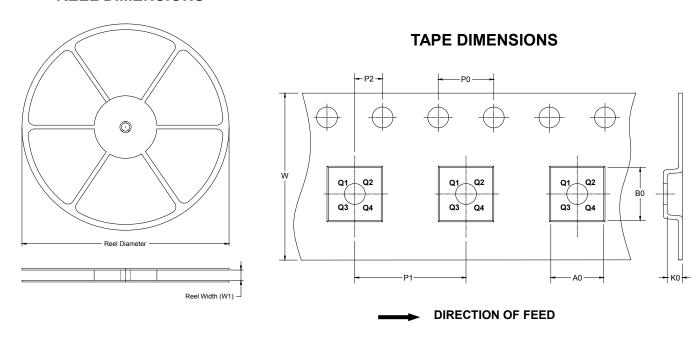




Symbol		nsions meters	Dimensions In Inches		
	MIN	MAX	MIN	MAX	
Α	0.820	1.100	0.032	0.043	
A1	0.020	0.150	0.001	0.006	
A2	0.750	0.950	0.030	0.037	
b	0.250	0.380	0.010	0.015	
С	0.090	0.230	0.004	0.009	
D	2.900	3.100	0.114	0.122	
E	2.900	3.100	0.114	0.122	
E1	4.750	5.050	0.187	0.199	
е	0.650	BSC	0.026	BSC	
L	0.400	0.800	0.016	0.031	
θ	0°	6°	0°	6°	

#### TAPE AND REEL INFORMATION

#### **REEL DIMENSIONS**

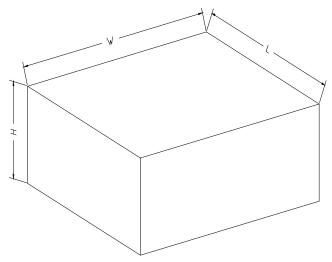


NOTE: The picture is only for reference. Please make the object as the standard.

#### **KEY PARAMETER LIST OF TAPE AND REEL**

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant	
SOIC-8	13"	12.4	6.40	5.40	2.10	4.0	8.0	2.0	12.0	Q1	
MSOP-8	13"	12.4	5.20	3.30	1.50	4.0	8.0	2.0	12.0	Q1	DD0001

#### **CARTON BOX DIMENSIONS**



NOTE: The picture is only for reference. Please make the object as the standard.

#### **KEY PARAMETER LIST OF CARTON BOX**

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton	
13"	386	280	370	5	000002